

REV.	SPECIFICATION	ECN NO.	APPD.
X4			

Material and Plating:

Housing: LCP, 30% Glass Filled,UL94V-0 , BLACK.

Power Contacts:High Conductivity Copper.

Au(3u")+Pd/Ni (27u") gold plated on Contact Area and 80u" Min Tin Plated on Solder Tail over nickel 50u" Min under plated .

Signal Contact: Phosphor Bronze.

Au(3u")+Pd/Ni (27u") gold plated on Contact Area and 80u" Min Tin Plated on Solder Tail over nickel 50u" Min under plated .

Electrical Characteristics:

Current Rating: Signal Pin 2.5 AMP.

Power Pin 60 AMP.

Dielectric Withstanding Voltage: DC 1500V For 1 minute.

Insulator Resistance: 5000MΩ min. at DC 500V.

Contact Resistance: Signal Pin 30mΩ max.

Power Pin 0.3mΩ max.

Operating Temperature: -40°C ~+105°C .

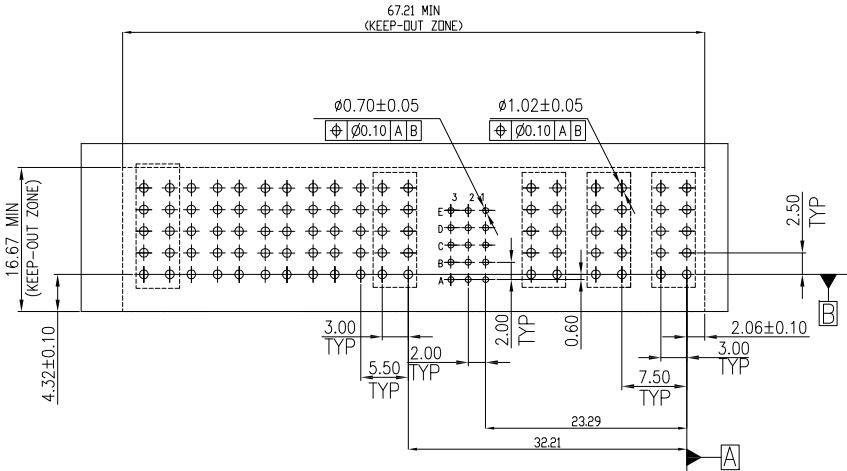
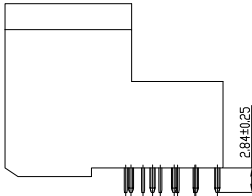
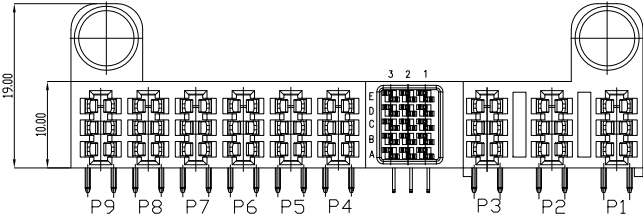
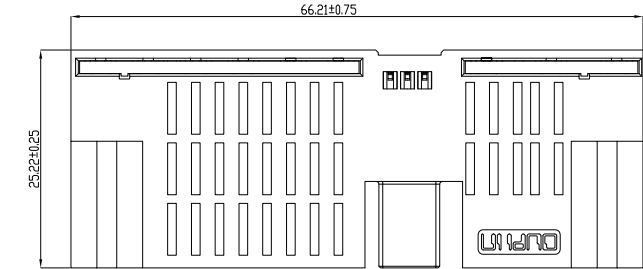
*RoHS Compliant

Notes :

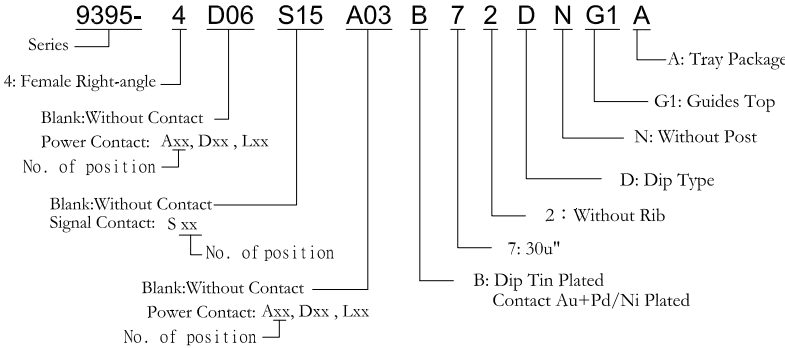
L: Low Power---PCB Mount 3.0mm Pitch

D: DC Power---PCB Mount 5.5mm Pitch

A: AC Power---PCB Mount 7.5mm Pitch



P.C.Board Layout
(Tolerance:±0.05)



Tolerances	Dwg. No.	9395-D0000-010	Title: 9395 Series Max P60 10mm Low Profile, 60Amp Receptable, Right Angle		OUPIN OUPIN ELECTRONIC(KUNSHAN) CO., LTD. P/N:9395-4D06S15A03B72DNG1A			
x = ±0.5 .x = ±0.25 .xx = ±0.15	Projection							
	Unit	mm	Scale	1:1				
	Drawn By	LQ 07/02'16			SHEET	1/2	Ver. No.	X4